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PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2644724

SUBMISSION TYPE:		NEW ASSIGN	NEW ASSIGNMENT			
NATURE OF CONVEYANCE:		ASSIGNMEN	ASSIGNMENT			
CONVEYING PARTY	DATA					
		Name		Execution Date	7	
HIDEAKI TAKEDA				11/05/2013	j	
RECEIVING PARTY	DATA					
Name:	UCHIYA THE	UCHIYA THERMOSTAT CO., LTD.				
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City:	SAITAMA				1	
State/Country:	JAPAN					
Postal Code:	341-0037					
Property Type		Number				
Application Number:		14125437				
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Phone: Email: Correspondence will Correspondent Name Address Line 1:	uspt <i>be sent via US Ma</i> s: SCH P.O	o@slwip.com <i>il when the email atten</i> WEGMAN, LUNDBER BOX 2938	G & WOESSNER, P.A.			
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Phone: Email: Correspondence will Correspondent Name Address Line 1:	uspf be sent via US Ma s: SCH P.O MIN	o@slwip.com <i>il when the email atten</i> WEGMAN, LUNDBER BOX 2938	G & WOESSNER, P.A. TA 55402			
Phone: Email: Correspondence will Correspondent Name Address Line 1: Address Line 4:	uspt be sent via US Ma E: SCH P.O MIN	o@slwip.com il when the email atten WEGMAN, LUNDBER BOX 2938 NEAPOLIS, MINNESO	G & WOESSNER, P.A. TA 55402			

12/11/2013

Total Attachments: 2

Date:

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REEL: 031759 FRAME: 0850

ASSIGNMENT

WHEREAS, I, <u>Hideaki TAKEDA</u>, residing at <u>c/o UCHIYA THERMOSTAT CO.</u>, <u>LTD.</u>, <u>2-176-1</u>, <u>Takasu</u>, <u>Misato-shi</u>, <u>Saitama 341-0037</u>, <u>Japan</u>, made certain new and useful inventions and improvements for which I executed an application for Letters Patent of the United States on <u>even date herewith</u>, which is entitled <u>TEMPERATURE SWITCH</u>;

AND WHEREAS, <u>UCHIYA THERMOSTAT CO.</u>, LTD., a corporation organized and existing under and by virtue of the laws of Japan, and having an office and place of business at <u>2-176-1</u>, <u>Takasu</u>, <u>Misato-shi</u>, <u>Saitama 341-0037</u>, <u>Japan</u> (hereinafter "Assignee"), is desirous of acquiring the entire right, title and interest in and to said inventions, improvements and application and in and to the Letters Patent to be obtained therefor;

NOW, THEREFORE, to all whom it may concern, be it known that for good and valuable consideration, the receipt and sufficiency whereof is hereby acknowledged, I have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto said Assignee, its successors or assigns, the entire right, title and interest for all countries in and to all inventions and improvements disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent which may be granted there from, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in any foreign countries for Letters Patent on the said inventions and improvements, including an assignment of all rights under the provisions of the International Convention, and all Letters Patent of foreign countries which may be granted there from; and I do hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent for the aforesaid inventions and improvements to the said Assignee as the assignee of the entire right, title and interest in and to the same, for the use of the said Assignee, its successors and assigns.

AND, for the consideration aforesaid, I do hereby agree that I and my executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors and representatives all facts known to me relating to said improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors or assigns the entire right, title and interest in and to the said improvements, inventions, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

PATENT REEL: 031759 FRAME: 0851 AND, furthermore, I covenant and agree with said Assignee, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property berein conveyed has been made to others by me and that full right to convey the same as herein expressed is possessed by me.

IN TESTIMONY WHEREOF, I have hereunto set my hand this the day of Alaureker, 2013.

The ball Takedo.

Hideaki TAKEDA

WITNESS:

Jakataki Kosugi

Name Takatoshi Kosugi

Date

Docket No: Serial Number: Not Assigned Filing Date: even date herewith Page 2 of 2

> PATENT REEL: 031759 FRAME: 0852

RECORDED: 12/11/2013